

تۛ / Descriptions

[illegible]

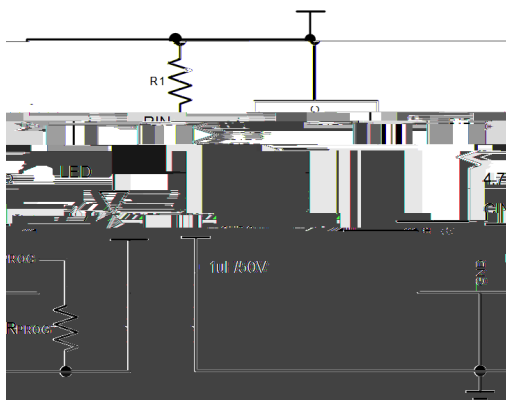
- / Features

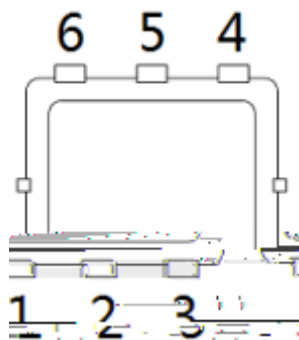
[illegible]

z v / Applications

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 X ɔ ɹ ǎ ɔ ʔH^H "
 ɓ w ɹ ɪ
 ʔH Ė 'Y ɓ ɪ

ϵ / Application Circuit





PIN Num.	Symbol	Function
		⌂
		⌂
		⌂
		⌂
	QF	⌂
	SURJ	⌂

PARAMETER	SYMBOL	RATINGS	UNITS
			†
			†
			†
			†

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
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[illegible]
$$7 \text{ W } \mathfrak{f} \approx \wedge \bar{\mathbf{I}}$$
[illegible]

BRCL4079YT-4.2



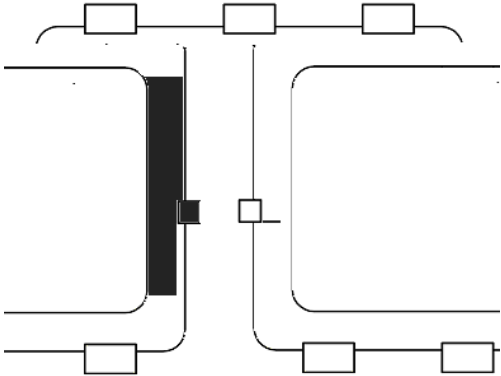
蓝箭电子
BLUE ROCKET ELECTRONICS

DATA SHEET

~ H 4²

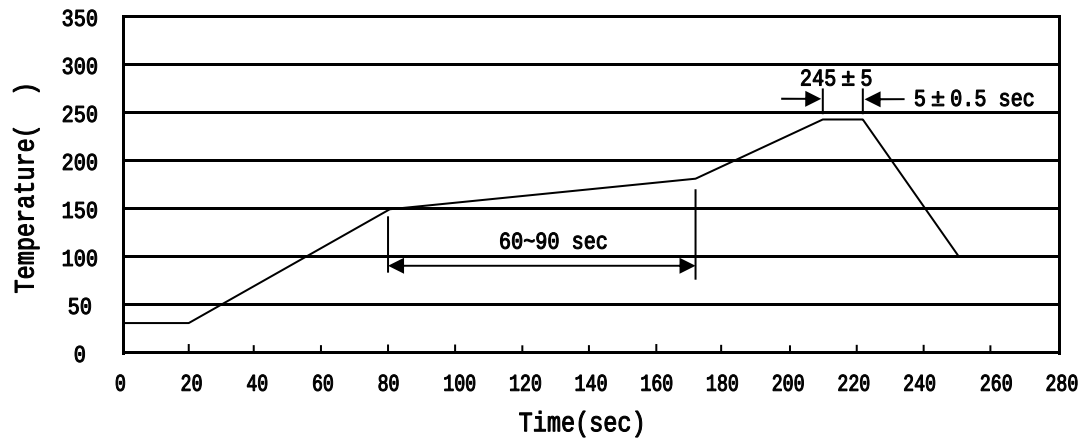
BRCL4079YT-4.2

4. 1. 2 / Marking Instructions



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73: <075	

温度冲击试验 / Whp shudwxuh Suriloh i ru LU Uhior z Vroghulqj+Se0luhh,



试验条件

试验温度: 150°C, 245 ± 5°C

试验时间: 60-90 sec, 5 ± 0.5 sec

试验次数: 1次

热阻测试 / Resistance to Soldering Heat Test Conditions

热阻测试: 150°C, 245 ± 5°C

包装规格 / Packaging SPEC.

包装规格

注意事项 / Notices

注意: 1. 试验前请检查元件是否完好。2. 试验过程中请勿触摸元件。3. 试验结束后请关闭电源。